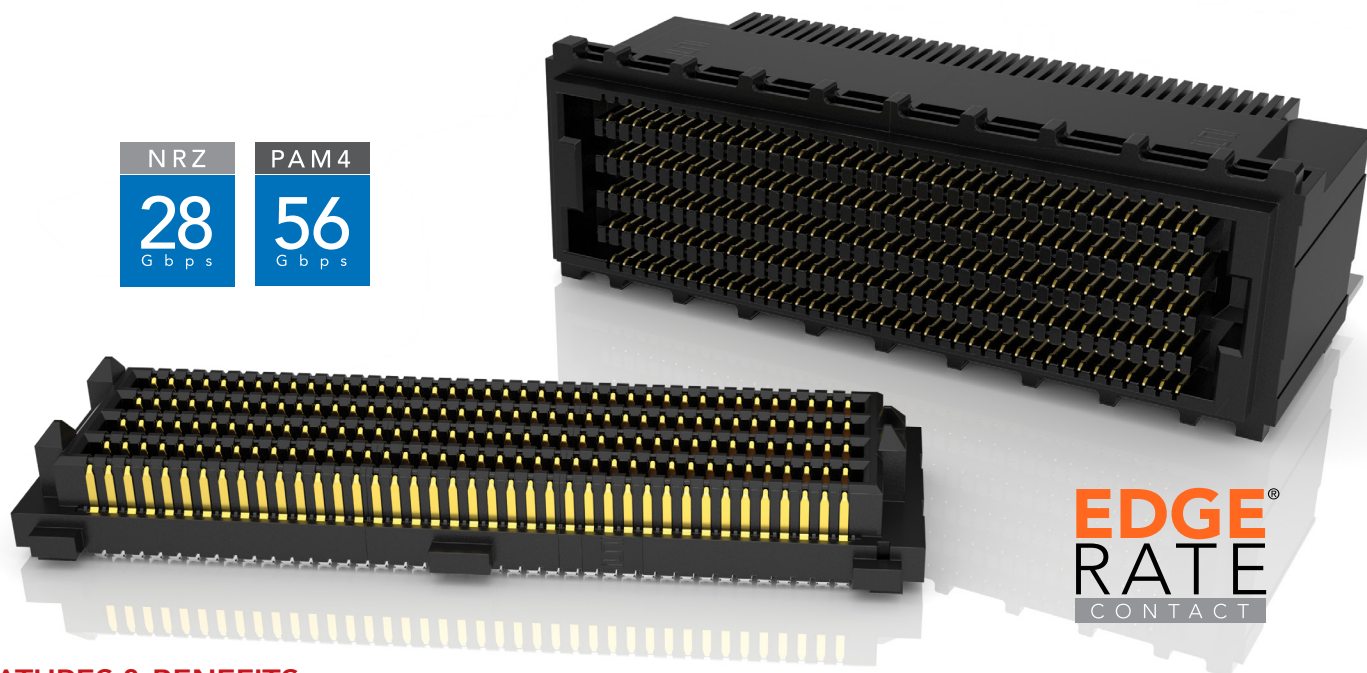


SEARAYTM.8mm

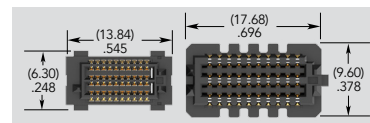
ULTRA HIGH-DENSITY, HIGH-SPEED OPEN-PIN-FIELD ARRAYS

(0.80 mm) .0315" PITCH

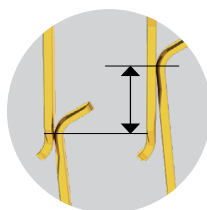


FEATURES & BENEFITS

- 0.80 mm (.0315") pitch grid
- 50% board space savings versus .050" (1.27 mm) pitch arrays
- Performance up to 28 Gbps NRZ/56 Gbps PAM4
- Rugged Edge Rate[®] contact system
- Up to 500 I/Os
- 7 mm and 10 mm stack heights
- Solder charge terminations for ease of processing
- Lower insertion/withdrawal forces
- Severe Environment Testing qualified (SEAM8/SEAF8); aligns with MIL-DTL-55302. Visit samtec.com/set

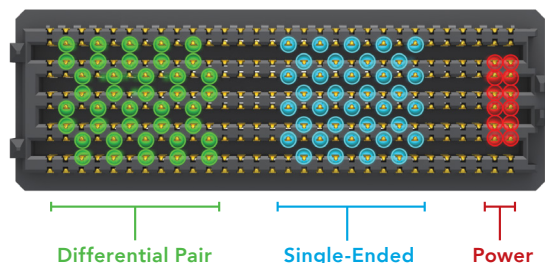


0.80 mm pitch vs. 1.27 mm pitch
(60 pins shown)



(1.12 mm) .044"
Nominal Wipe

MAXIMUM GROUNDING & ROUTING FLEXIBILITY



KEY SPECIFICATIONS (SEAF8/SEAM8)

SERIES	INSULATOR MATERIAL	CONTACT MATERIAL	PLATING	OPERATING TEMP RANGE	CURRENT RATING	VOLTAGE RATING	LEAD-FREE SOLDERABLE
SEAM8	Black LCP	Copper Alloy	Au or Sn over 50 μ " (1.27 μ m) Ni	-55 °C to +125 °C	1.3 A per pin (10 adjacent pins powered)	220 VAC/311 VDC	Yes
SEAF8					1.1 A per pin (10 adjacent pins powered)	240 VAC/339 VDC	
SEAF8-RA							

(0.80 mm) .0315" PITCH • ULTRA HIGH-DENSITY ARRAYS

SERIES	NO. PINS PER ROW	LEAD STYLE	PLATING OPTION	NO. OF ROWS	SOLDER TYPE	OPTION	"X"R
SEAM8 Terminal	-10, -20, -30, -40, -50	-S02.0 = 2 mm Body Height (SEAM8 only)	-L = 10 μ" (0.25 μm) Gold on contact area, Matte Tin on solder tail	-04 -06 -08 -10	-1 = Tin/Lead Alloy Solder Crimp (-STL only)	-GP = Guide Post (-S02.0 lead style only) (Mates with SEAF8-RA-GP)	Tape & Reel is standard. Leave blank for Tape & Reel.
SEAF8 Socket		-S05.0 = 5 mm Body Height (SEAM8 only)	-S = 30 μ" (0.76 μm) Gold on contact area, Matte Tin on solder tail		-3 = Lead-Free Solder Crimp		-FR = Full Reel Tape & Reel (must order max. quantity per reel; contact Samtec for quantity breaks)
		-05.0 = 5 mm Body Height (SEAF8 only)	-STL = 30 μ" (0.76 μm) Gold on contact, Tin/Lead on solder tail (-1 solder type only)				

SEAM8

Board Mates:
SEAF8

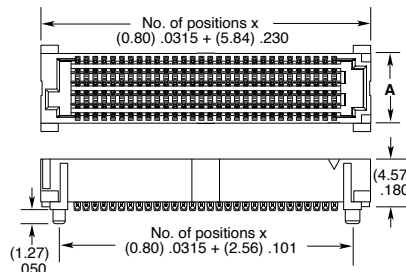
Cable Mates:
ESCA

Standoffs:
JSO

LEAD STYLE	B
-S02.0	(4.54) .179
-S05.0	(7.54) .297

View complete specifications at: samtec.com?SEAM8

SEAF8	Board Mates: SEAM8
Cable Mates: ESCA	Standoffs: JSO



View complete specifications at: samtec.com?SEAF8

MATED HEIGHTS*

SEAF8 LEAD STYLE	SEAM8 LEAD STYLE	
	-S02.0	-S05.0
-05.0	(7.00) .276	(10.00) .394

*Processing conditions will affect mated height.

Notes:
Polyimide Pick & Place Pad
standard without specifying -K.

Severe Environment Testing
qualified; aligns with MIL-DTL-55302.
Visit samtec.com/set

SEAF8	NO. PINS PER ROW	1	PLATING OPTION	NO. OF ROWS	SOLDER TYPE	RA	OPTION	"X"R
	-20, -30, -40, -50		-S = 30 μ" (0.76 μm) Gold on contact area, Matte Tin on solder tail	-04 (-50 positions only) -08 -10	-2 = Lead-Free Solder Crimp		-GP = Guide Post Holes	Tape & Reel is standard. Leave blank for Tape & Reel.
								-FR = Full Reel Tape & Reel (must order max. quantity per reel; contact Samtec for quantity breaks)

SEAF8-RA
(Right-angle)

Board Mates:
SEAM8

Cable Mates:
ESCA

NO. OF ROWS	A	B
-04	(12.48) .491	(7.46) .294
-08	(16.48) .649	(11.46) .451
-10	(18.48) .728	(13.46) .530

Notes:
Some sizes, styles and
options are non-standard,
non-returnable

View complete specifications at: samtec.com?SEAF8-RA

Mouser Electronics

Authorized Distributor

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[Samtec:](#)

[SEAF8-10-05.0-S-04-2-K](#) [SEAF8-30-05.0-S-10-2-K](#) [SEAF8-10-05.0-S-06-2-K](#) [SEAF8-10-05.0-S-10-2-K](#) [SEAF8-50-05.0-S-08-2-K](#) [SEAF8-50-05.0-L-08-2-K](#) [SEAF8-20-05.0-L-04-2-K](#) [SEAF8-40-05.0-S-10-2-K](#) [SEAF8-10-05.0-L-10-2-K](#)
[SEAF8-40-05.0-L-04-2-K](#) [SEAF8-30-05.0-L-08-2-K](#) [SEAF8-20-05.0-L-08-2-K](#) [SEAF8-40-05.0-L-06-2-K](#)